

Data Sheet

Rev. 1.00 / April 2012

ZSPM4121

Under-Voltage Load Switch for Smart Battery Management



Under-Voltage Load Switch for Smart Battery Management











Brief Description

The ZSPM4121 battery management load switch can be used to protect a battery from excessive discharge. It actively switches the battery power source off if it drops to a set threshold (Off Mode). When the input battery voltage is above the threshold, the load switch is on (On Mode). The ZSPM4121 threshold voltage (V_{THRESH}) is programmed at manufacturing to a set point in the range of 1.2V to 4.2V with 100mV steps between options.

When the input battery voltage has been switched off by the ZSPM4121, the quiescent current draw on the battery is in the order of 100pA (typical). The quiescent current in the on state is as low as 70nA.

The ZSPM4121 consists of an internally generated threshold voltage, a comparator with hysteresis, slew rate control for the load switch, a P-channel load switch, and an open-drain indicator pin. The 500mV hysteresis between the Off Mode and the On Mode prevents intermittent operation. The ZSPM4121 also provides over-current protection.

Benefits

- Best-in-class ultra-low quiescent current in Off Mode: 100pA (typical)
- Ultra-low quiescent current in On Mode: 70nA (typical)
- Accurate on/off voltage threshold
- Low Rds(on): 175mΩ (typical) @ 5V

Features

- Power source is actively switched off when VCC drops below a set threshold (programmed at manufacturing)
- Wide input voltage range: 1.2V to 5.5V
- Threshold voltage options of 1.2V to 4.2V in 100mV steps (factory programmed)
- · Supervisory over-current limit shutdown
- Low drop out disconnect from VCC to loads
- Controlled turn-on slew rate
- 500mV Off Mode to On Mode hysteresis
- Over current shutdown (3A)

Related ZMDI Smart Power Products

• ZSPM4141 Ultra-Low-Power Linear Regulator

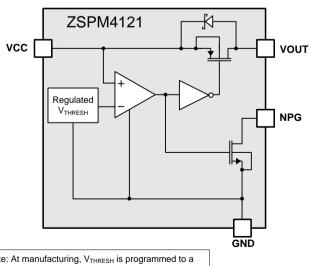
Available Support

- Evaluation Kit
- Support Documentation

Physical Characteristics

• Package: 8-pin DFN (2mm x 2mm)

ZSPM4121 Block Diagram



Note: At manufacturing, V_{THRESH} is programmed to a customer-selected threshold voltage in the range of 1.2V to 4.2V with 100mV steps between options.





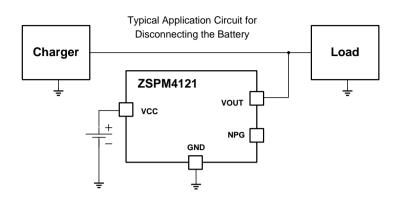






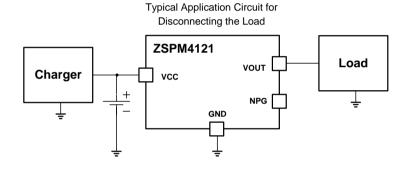


Typical Application Circuits:



Typical Applications

- · Portable Batteries
- Industrial
- Medical
- Smart cards
- RFID



Ordering Information

| Ordering Code* | Description | Package |
|-------------------------|--|----------------------------|
| ZSPM4121AI1 <i>W</i> 17 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 1.7V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121AI1W21 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.1V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121AI1 <i>W</i> 23 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.3V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121AI1 <i>W</i> 24 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.4V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121AI1 <i>W</i> 25 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.5V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121AI1 <i>W</i> 26 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.6V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121AI1 <i>W</i> 28 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.8V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121AI1 <i>W</i> 30 | ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 3.0V | 8-pin DFN / 7" Reel (2500) |
| ZSPM4121KIT | ZSPM4121 Evaluation Kit | |

^{*} X = W for 7" reel with 2500 parts or R for 13" reel with 3300. Custom V_{THRESH} values are also available: 1.2V to 4.2V (typical) in 100mV increments.

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| | in Description, 8-Pin DFN (2x2) | |













1 ZSPM4121 Characteristics

Stresses beyond those listed under "Absolute Maximum Ratings" (section 1.1) may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those recommended under "Recommended Operating Conditions" (section 1.3) is not implied. Exposure to absolute—maximum conditions for extended periods may affect device reliability.

1.1. Absolute Maximum Ratings

Over operating free—air temperature range unless otherwise noted. All voltage values are with respect to network ground terminal.

Table 1.1 Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|------------------|-------------|------|
| Maximum voltage applied to the VCC, VOUT, and NPG pins | | -0.3 to 6.0 | V |
| Electrostatic Discharge – Human Body Model, according to the respective JESD22 JEDEC standard | | 2 | kV |
| Operating Junction Temperature Range | TJ | -20 to 85 | °C |
| Storage Temperature Range | T _{stg} | -65 to 150 | °C |
| Lead Temperature (soldering, 10 seconds) | | 260 | °C |

1.2. Thermal Characteristics

Table 1.2 Thermal Characteristics for 8-Pin DFN (2mm x 2mm) Package

| θ _{JA} (°C/W) ¹⁾ | | θ _{JC} (°C/W) ²⁾ | |
|--------------------------------------|--|--------------------------------------|--|
| | 73.1 | 10.7 | |
| 1) | This rating assumes a FR4 board only. | | |
| 2) | 2) This rating assumes a 1oz. copper JEDEC standard board with thermal vias. See section 6.1 for more information. | | |

1.3. Recommended Operating Conditions

Table 1.3 Recommended Operating Conditions

| Parameter | Symbol | Min | Тур | Max | Unit |
|--|-----------------|-----|-----|-----|------|
| Unregulated Supply Input at VCC pin | V _{CC} | 1.2 | | 5.5 | V |
| Operating Ambient Temperature 1) | T _A | -20 | | 55 | °C |
| Operating Junction Temperature | TJ | -20 | | 85 | °C |
| 1) Our first shirt the same in the first shirt and the same in the first shirt in the same | | | | | |

Operating ambient temperature is only intended as a guideline. The operating junction temperature requirements must not be exceeded.













1.4. Electrical Characteristics

Electrical characteristics for V_{CC} = 1.2V to 5.5 (unless otherwise noted). Minimum and maximum characteristics are tested at T_J = 25°C.

Table 1.4 Electrical Characteristics

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|---------------------------------------|-----------------------|---|-------------------------------|---------------------|-------------------------------|------|
| Input Supply | | | | | | |
| Input Supply Voltage at VCC pin | V _{CC} | | 1.2 | | 5.5 | V |
| Quiescent Current: On Mode | I _{q-ON} | V _{CC} = 5V, no load | | 70 | 150 | nA |
| Quiescent Current: Off Mode | I _{q-OFF} | V _{CC} < V _{THRESH} , no load | | 100 | | рА |
| Load Switch | | | | | | |
| Over-Current Shutdown | loc | V _{CC} = 5.0V | | 3 | | Α |
| Over-Current Retry Period | toc | V _{CC} = 5.0V | | 1.7 | | ms |
| Output Switch Leakage Current | I _{LEAK-SW} | V _{CC} < V _{THRESH} ; V _{OUT} grounded | | 100 | | рА |
| Switch ON-Resistance | Rds-on | V _{CC} = 5.0V | | 175 | | mΩ |
| | | V _{CC} = 3.3V | | 200 | | mΩ |
| | | V _{CC} = 1.8V | | 350 | | mΩ |
| Transition Times | | | | | | |
| Transition Delay: On Mode to Off Mode | t _{d1} | $V_{OFF} = 2.0V$, $V_{CC} = 3.0V \rightarrow 1.5V$ | | 650 | | μS |
| Transition Delay: Off Mode to On Mode | t _{d2} | $V_{OFF} = 2.0V$, $V_{CC} = 1.5V \rightarrow 3.0V$ | | 1.7 | | ms |
| Output Turn-on Rise Time | t _{ON} | $V_{CC} = 2.5V$, $R_{LOAD} = 50\Omega$ | | 200 | | μs |
| NPG Output | | | | | | |
| Output Leakage | I _{LEAK-NPG} | $V_{CC} = 5.0V, V_{NPG} = 5.5V$ | | | 100 | nA |
| Low-Level Output Voltage | V _{OL-NPG} | I _{NPG} = 5 mA | | | 0.4 | V |
| Off Thresholds | | | | | | |
| Off Threshold | V _{OFF} | V _{THRESH} = customer-selected threshold voltage in the range of 1.2V to 4.2V with 100mV steps between options programmed at manufacturing | 0.95 * V _{THRESH} | V _{THRESH} | 1.05 * V _{THRESH} | V |
| Off Mode to On Mode Hysteresis | V _{Hys} | Rising Transition: Off Mode to On Mode | | 500 | | mV |





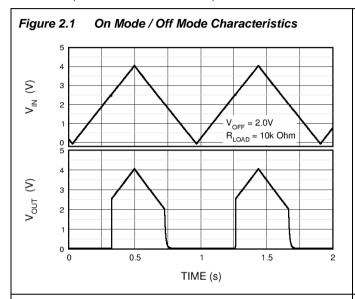






2 Typical Performance Characteristics

T = 25°C (unless otherwise noted)



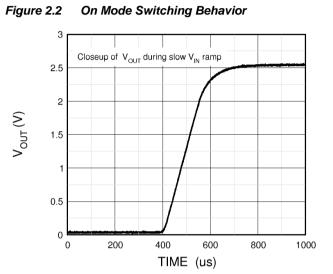
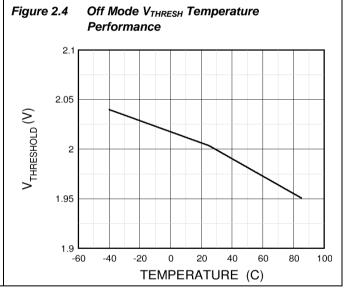


Figure 2.3 On Mode / Off Mode Quiescent Current I_q

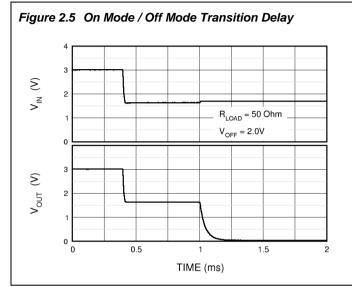
5
4
3
7
1
0
V_{OFF} = 2.0V
0
0
1
2
2e-08
0
0
1
2
3
4
5
V_{IN} (V)

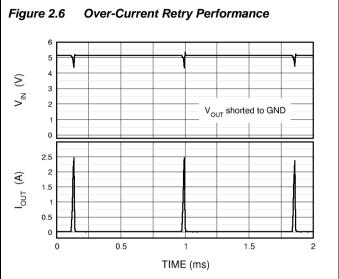








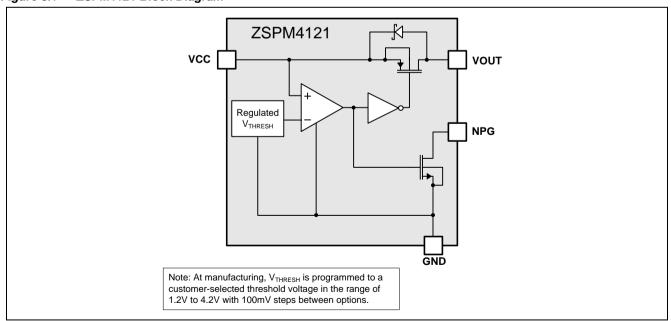




3 Description of Circuit

The ZSPM4121 battery management load switch consists of an internally generated threshold voltage, comparator with hysteresis, slew rate control for the load switch, a P-channel load switch, and an open-drain indicator pin. When the input battery voltage is above the factory-configured threshold, the load switch is on (the On Mode). When the input battery voltage falls to the threshold voltage or below, the load switch is off (the Off Mode), and the quiescent current draw on the battery is in the order of 100pA (typical). The ZSPM4121 threshold voltage is programmed at manufacturing to an option in the range of 1.2V to 4.2V with 100mV steps between options. The 500mV hysteresis between the Off Mode and the On Mode prevents intermittent operation. The ZSPM4121 also provides over-current protection.

Figure 3.1 ZSPM4121 Block Diagram







4 Application Circuits

4.1. Typical Application Circuits

Note that when the ZSPM4121 is in Off Mode, the battery will continue to charge through the body diode between VOUT and VCC for the application shown in Figure 4.1.

Figure 4.1 Application Circuit for Disconnecting the Battery

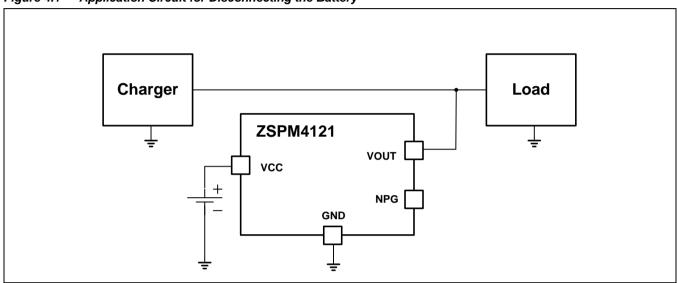
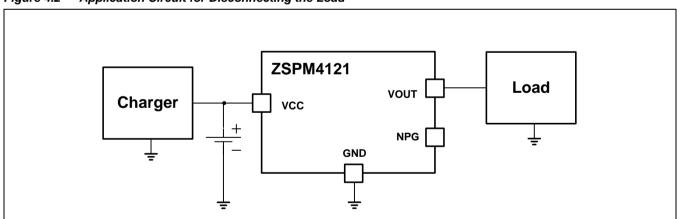


Figure 4.2 Application Circuit for Disconnecting the Load









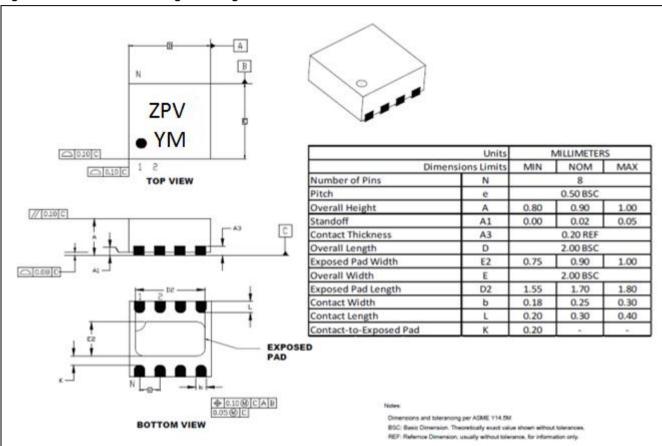






5.1. Package Dimensions and Marking Diagram

Figure 5.1 ZSPM4121 Package Drawing



MARKING CODES:

Z: ZMDI

P: Product Code

Voltage levels: 1 = 1.2V, 2 = 1.3V, 3 = 1.4V, 4 = 1.5V, 5 = 1.6V, 6 = 1.7V, 7 = 1.8V. 8 = 1.9V, 9 = 2.0V, A = 2.1 V, B = 2,2 V, C = 2.3 V, D = 2.4 V, E - V = 2.5V to 4.2V

YM: Date Code (Year, Month)







5.2. Pin Description for 8-Pin DFN (2x2 mm)

Figure 5.2 ZSPM4121 Pin Assignments (top view)

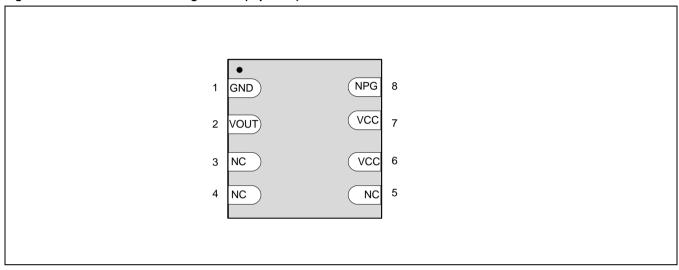


Table 5.1: Pin Description, 8-Pin DFN (2x2)

| Pin# | Name | Function | Description |
|------|------------------|----------|--|
| 1 | GND | Ground | GND |
| 2 | V _{OUT} | Output | Output to System Load |
| 3 | NC | | No Connection (connect to GND or float) |
| 4 | NC | | No Connection (connect to GND or float) |
| 5 | NC | | No Connection (connect to GND or float) |
| 6 | VCC | Supply | Supply Input (connect to pin 7 and VCC supply rail) |
| 7 | VCC | Supply | Supply Input (connect to pin 6 and VCC supply rail) |
| 8 | NPG | Output | Open-Drain N-Channel Output (low indicates "Power Good") |



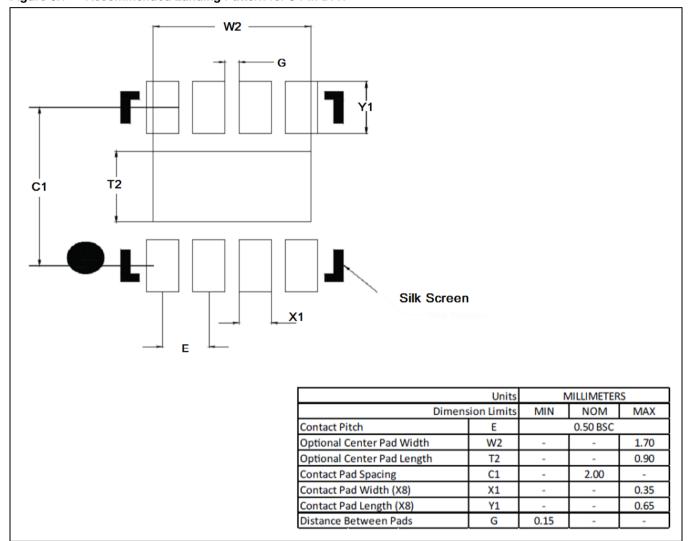


6 Layout and Soldering Requirements

To maximize the efficiency of this package for applications on a single layer or multi-layer printed circuit board (PCB), certain guidelines must be followed when laying out this part on the PCB.

6.1. Recommended Landing Pattern for PCBs

Figure 6.1 Recommended Landing Pattern for 8-Pin DFN



Under-Voltage Load Switch for Smart Battery Management





6.2. Multi-Layer PCB Layout

The following are guidelines for mounting the exposed pad ZSPM4121 on a multi-Layer PCB with ground a plane. In a multi-layer board application, the thermal vias are the primary method of heat transfer from the package thermal pad to the internal ground plane. The efficiency of this method depends on several factors, including die area, number of thermal vias, and thickness of copper, etc.

Figure 6.2 Package and PCB Land Configuration for Multi-Layer PCB

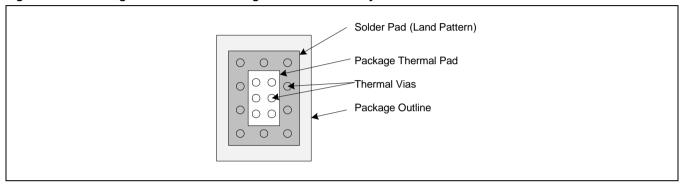


Figure 6.3 JEDEC Standard FR4 Multi-Layer Board - Cross-Sectional View

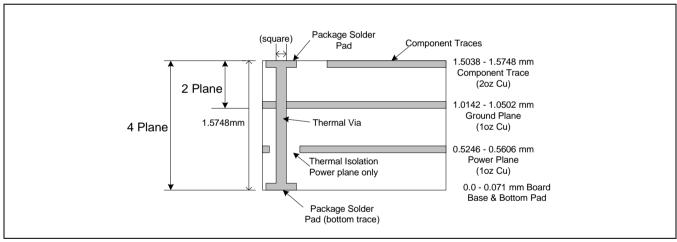


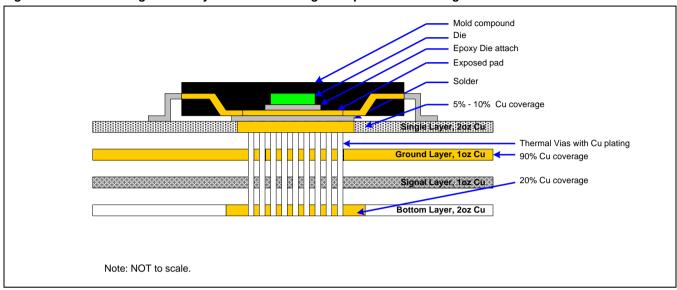
Figure 6.4 is a representation of how the heat can be conducted away from the die using an exposed pad package. Each application will have different requirements and limitations, and therefore the user should use sufficient copper to dissipate the power in the system. The output current rating for the linear regulators might need to be de-rated for ambient temperatures above 85°C. The de-rated value will depend on calculated worst case power dissipation and the thermal management implementation in the application.







Figure 6.4 Conducting Heat Away from the Die using an Exposed Pad Package

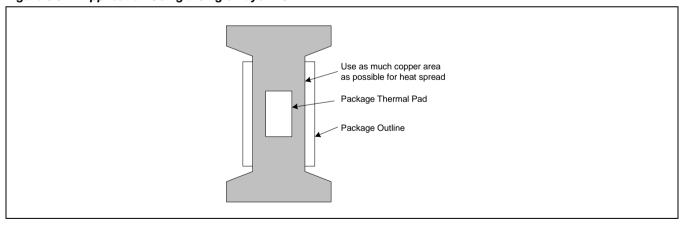


6.3. Single-Layer PCB Layout

Layout recommendations for a single-layer PCB: Utilize as much copper area for power management as possible. In a single-layer board application, the thermal pad is attached to a heat spreader (copper areas) by using a low thermal impedance attachment method (solder paste or thermal conductive epoxy).

In both of the methods mentioned above, it is advisable to use as much copper trace as possible to dissipate the heat.

Figure 6.5 Application Using a Single-Layer PCB



Important: If the attachment method is NOT implemented correctly, the functionality of the product is NOT guaranteed. Power dissipation capability will be adversely affected if the device is incorrectly mounted onto the circuit board.













7 Ordering Information

| Ordering Code* | Description | Package |
|-------------------------|--|----------------------------|
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| ZSPM4121KIT | ZSPM4121 Evaluation Kit | |

^{*} Custom values are also available in the range of 1.2V - 4.2V (typical) in 100mV increments.

8 Related Documents

| Document | File Name |
|--|---|
| ZSPM4121 Feature Sheet | ZSPM4121_Feature_Sheet_revX_xy.pdf |
| ZSPM4121 Evaluation Kit Description | ZSPM4121_Eval_Kit_Description_revX_xy.pdf |
| ZSPM4121 Application Note—Low Power Battery Control and Voltage Regulator Solutions for Remote Sensor Networks | ZSPM4121_App_Note_LP-Batt-Contr-VReg-Remote-Sensor-Net_X_xy.pdf |

Note: *X_xy* refers to the current revision of the document.

Visit ZMDI's website www.zmdi.com or contact your nearest sales office for the latest version of these documents.

9 Glossary

| Term | Description |
|------|---|
| PG | Power Good (NPG = Power Good, active low) |
| RFID | Radio Frequency Identification |
| SPM | Smart Power Management |

Under-Voltage Load Switch for Smart Battery Management











10 Document Revision History

| Revision | Date | Description |
|----------|----------------|---------------|
| 1.00 | April 30, 2012 | First release |

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